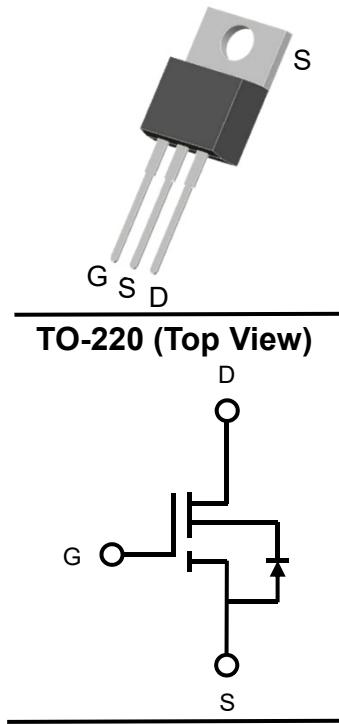


## 650V Enhancement-mode GaN Transistor

### Description

650V Normally-OFF GaN			
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (mΩ)	I <sub>DS</sub> (A)	Q <sub>G</sub> (nC)
650	110	20	7.2



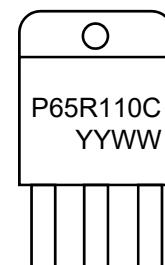
### Feature

- Normally-off device combines high voltage GaN HEMT and low voltage silicon MOSFET
- Normally off power switch
- Low reverse-recovery charge
- High switching frequency
- Low gate charge, low output charge
- Qualified for industrial applications according to JEDEC Standards
- Package:TO-220

### Applications

- Fast charger
- Renewable energy
- Telecom and data-com
- Servo motors
- Industrial
- Automotive

### Circuit Diagram



### Marking (Top View)

### Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-Source Voltage	V <sub>DS</sub>	650	V
Drain-Source Voltage-transient <sup>1)</sup>	V <sub>DS(transient)</sub>	900	V
Gate-Source Voltage	V <sub>GS</sub>	-20 to +20	V
Drain Current-Continuous <sup>2)</sup>	I <sub>D</sub>	20	A
		9.0	A
Pulse Drain Current (pulse width: 100μs)	I <sub>DM</sub>	75	A
Maximum Power Dissipation	P <sub>D</sub>	96	W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~+150	°C

Notes:

1. In off-state, spike duty cycle D<0.01, spike duration <1μs
2. For increased stability at high current operation.

# Gallium Nitride

# PGCTO65R110A

## Thermal characteristics

Parameter	Symbol	Min.	Typ.	Max.	Units
Thermal Resistance, Junction - Case	$R_{\theta JC}$	-	1.3	-	°C/W

## Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V$	650	-	-	V
Total Drain Leakage Current	$I_{DSS}$	$V_{DS} = 650V, V_{GS} = 0V$	-	-	10	μA
		$V_{DS} = 650V, V_{GS} = 0V, T_j = 150^\circ C$	-	-	100	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 1mA$	1.0	1.9	3.0	V
Gate Threshold Voltage Temperature Coefficient	$\Delta V_{GS(th)}/T_j$		-	-7	-	mV/°C
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V$	-	-	± 100	nA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 1A$	-	110	140	mΩ
		$V_{GS} = 10V, I_D = 1A, T_j = 150^\circ C$	-	230	-	
Input Capacitance	$C_{iss}$	$V_{DS} = 400V, V_{GS} = 0V, f = 1MHz$	-	243	-	pF
Output Capacitance	$C_{oss}$		-	34	-	
Reverse Transfer Capacitance	$C_{rss}$		-	1.5	-	
Output Charge	$Q_{oss}$	$V_{GS} = 0V, V_{DS} = 0V$ to $400V$	-	46	-	nC
Total Gate Charge	$Q_g$	$V_{GS} = 0$ to $10V, V_{DS} = 400V, I_D = 1A$	-	7.2	-	nC
Gate-Source Charge	$Q_{gs}$		-	2.3	-	
Gate-Drain Charge	$Q_{gd}$		-	2.9	-	
Turn-on Delay Time	$t_{d(on)}$	$V_{DS} = 400V, V_{GS} = 0V$ to $10V, I_D = 2.1A, R_{G-on(ext)} = 6.8\Omega, R_{G-off(ext)} = 2.2\Omega, L = 250\mu H$	-	6.0	-	ns
Turn-on Rise Time	$t_r$		-	17	-	
Turn-Off Delay Time	$t_{d(off)}$		-	7.0	-	
Turn-Off Fall Time	$t_f$		-	15	-	
Reverse Device Characteristics						
Diode Forward Voltage	$V_{SD}$	$V_{GS} = 0V, I_{SD} = 10A$	-	2.5	-	V
Reverse Recovery Time	$t_{rr}$	$I_F = 10A, V_{DD} = 400V, dI_F/dt = 165A/\mu s$	-	14	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	6.5	-	nC

## Typical Characteristics

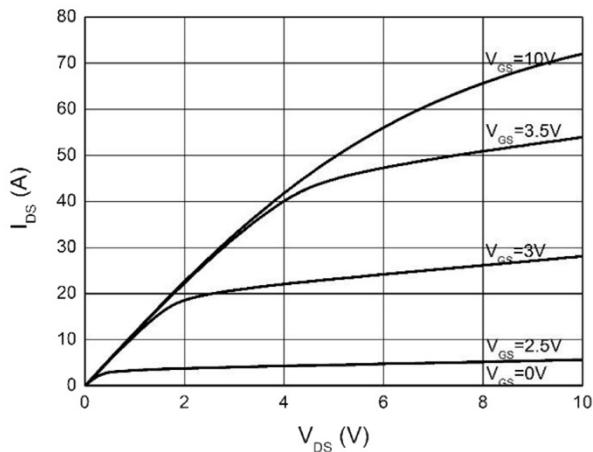
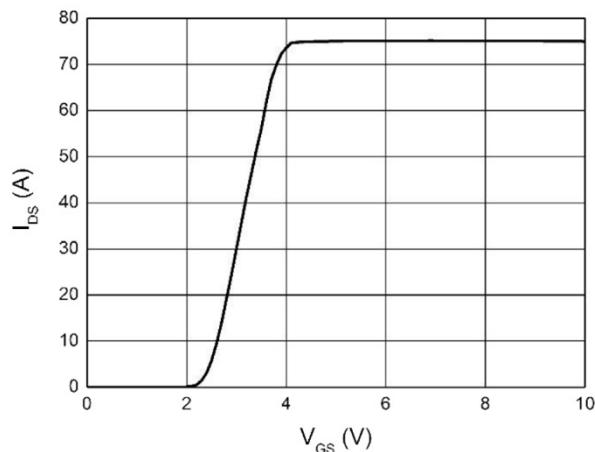
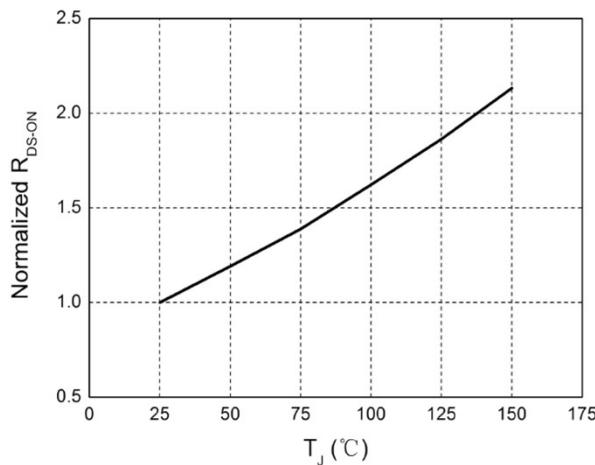
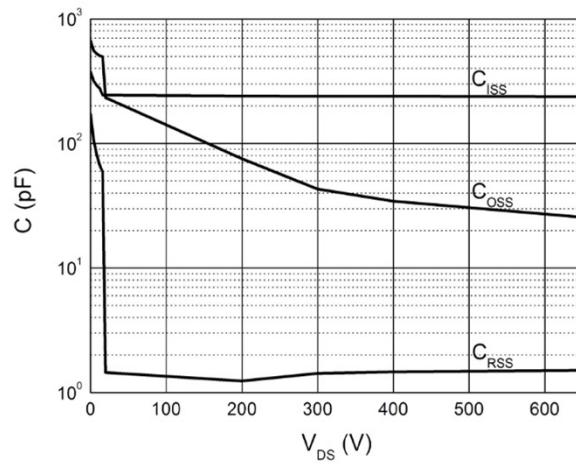
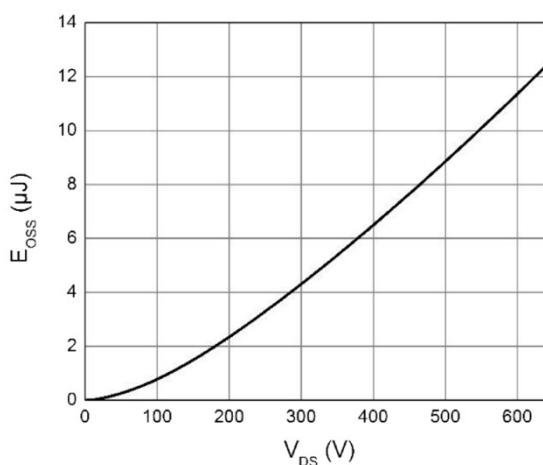
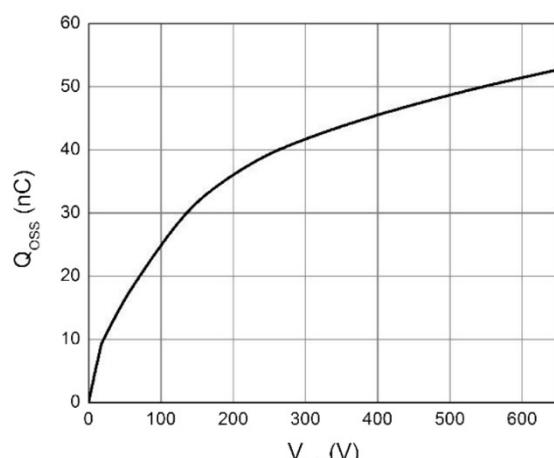
Figure 1. Typical Output Characteristics  $T_J=25^\circ\text{C}$ Figure 2. Typical Transfer Characteristics  $T_J=25^\circ\text{C}$  ( $V_{DS}=10V$ )

Figure 3. Normalized On-resistance

Figure 4. Typical Capacitance ( $f=1\text{MHz}$ )Figure 5. Typical  $C_{OSS}$  Stored EnergyFigure 6. Typical  $Q_{OSS}$

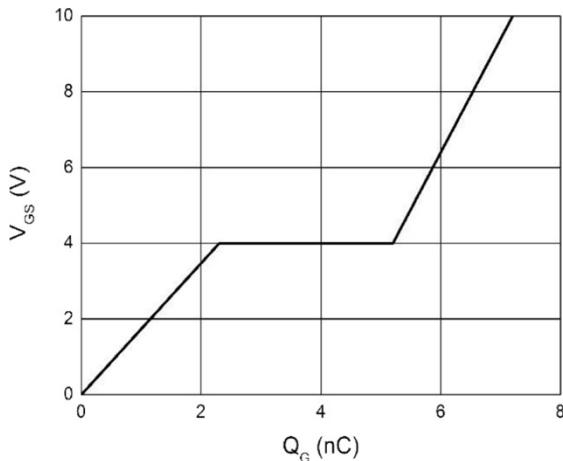


Figure 7. Typical Gate Charge ( $V_{DS}=400V$ ,  $I_D=1A$ )

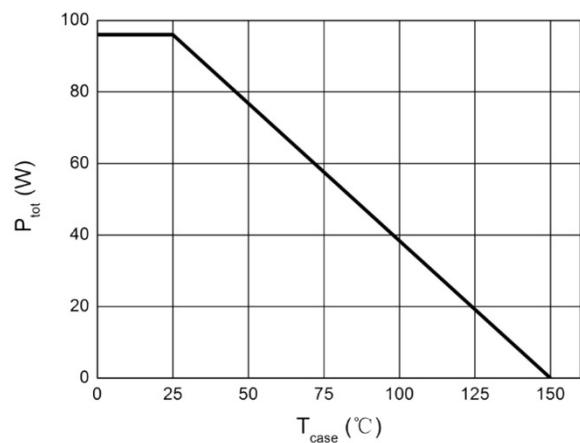


Figure 8. Power Dissipation

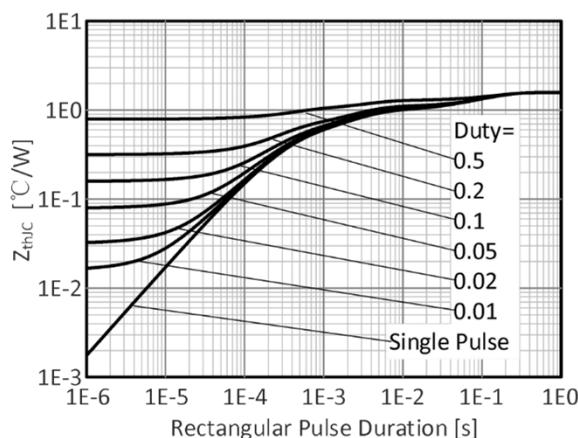


Figure 9. Transient Thermal Resistance

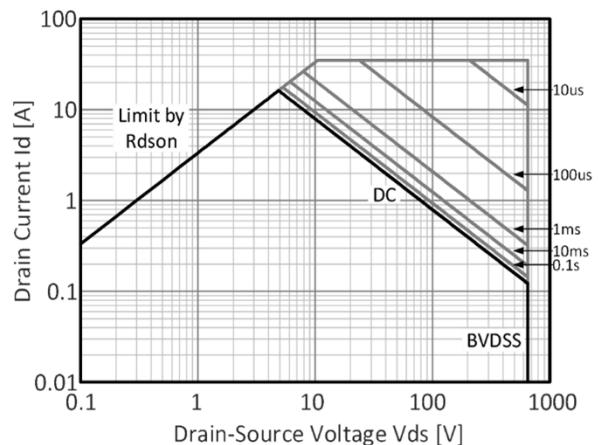


Figure 10. Safe Operating Area  $T_c=25^\circ C$

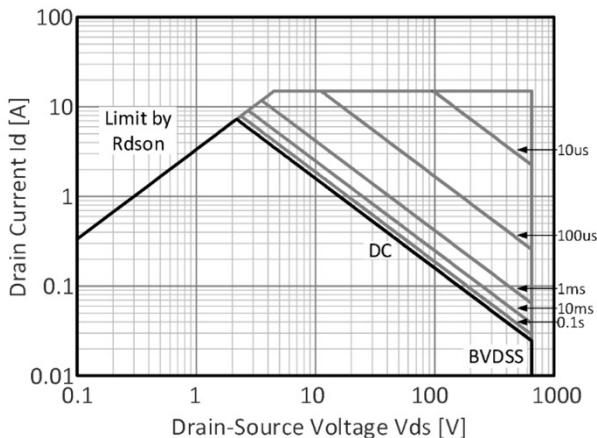
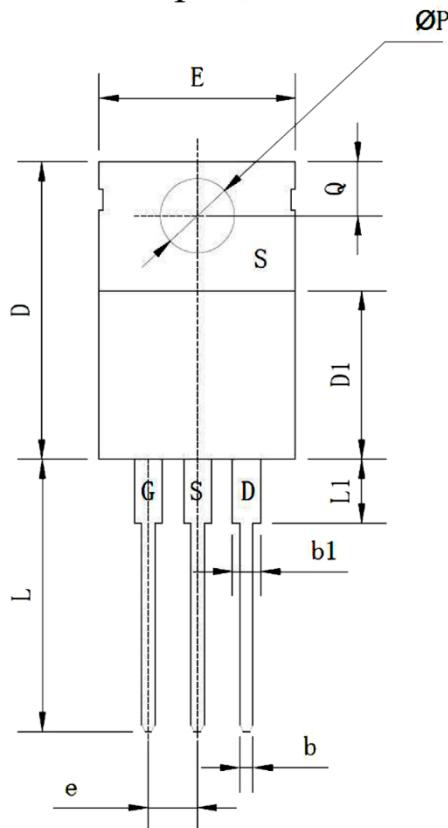


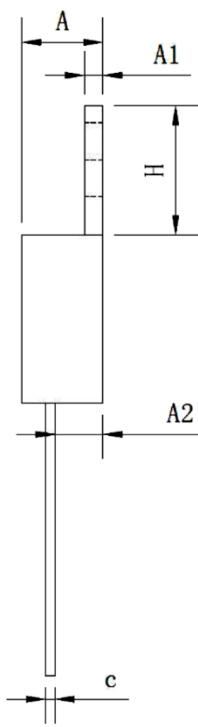
Figure 11. Safe Operating Area  $T_c=125^\circ C$

## Product Dimension (TO-220)

Top view



Side view



Dim	Millimeters		Inches		Dim	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	3.556	4.826	0.140	0.190	b	0.381	1.016	0.015	0.040
A1	0.508	1.397	0.020	0.055	b1	1.143	1.778	0.045	0.070
A2	2.032	2.921	0.080	0.115	D	14.224	16.510	0.560	0.650
c	0.356	0.610	0.014	0.024	D1	8.382	9.017	0.330	0.355
H	5.842	6.858	0.230	0.270	Q	2.54	3.048	0.100	0.120
E	9.652	10.668	0.380	0.420	L	12.70	14.732	0.500	0.580
ØP	3.81	3.86	0.150	0.152	L1	-	6.35	-	0.250
e	2.54 BSC.		0.100 BSC.						

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